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Specification for Approval

Customer:	
Model Name:	

Sı	Customer approval		
R&D Designed	R&D Approved	QC Approved	
Peter	Peng Jun		

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Revision Record

REV NO.	REV DATE	CONTENTS	Note
А	2012-07-10	NEW ISSUE	
В	2014-12-09	Modify brightness	

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1. Scope

This specification defines general provisions as well as inspection standards for TFT module supplied by AMSON electronics.

If the event of unforeseen problem or unspecified items may occur, naturally shall negotiate and agree to solution.

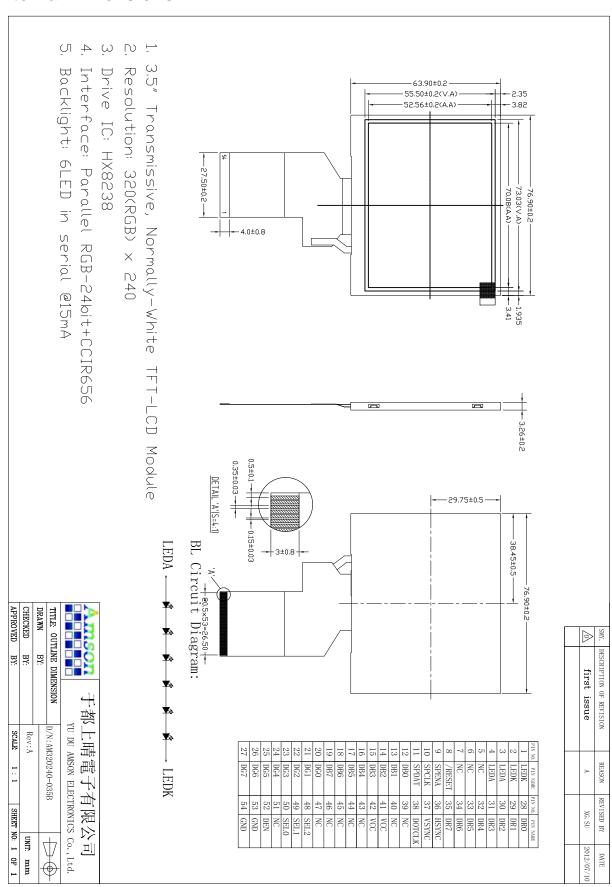
2. General Information

ITEM	STANDARD VALUES	UNITS
LCD type	3.5"TFT	
Dot arrangement	320(RGB)×240	dots
Color filter array	RGB vertical stripe	
Display mode	TN / Transmissive / Normally White	
Viewing Direction	6 o'clock(Gray scale inversion)	
Driver IC	HX8238-D	
Module size	76.9(W)×63.9(H)×3.26(T)	mm
Active area	70.08(W)×52.56(H)	mm
Dot pitch	0.219(W)×0.219(H)	mm
Interface	24 bits RGB with Serial Interface / CCIR656	
Operating temperature	-20 ~ +70	°C
Storage temperature	-30 ~ +80	°C
Back Light	? White LED	
Weight	TBD	g

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3. External Dimensions





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4. Interface Description

4. Interface Description					
PIN NO.	PIN NAME	DESCRIPTION			
1	LEDK	LED backlight cathode			
2	LEDK	LED backlight cathode			
3	LEDA	LED backlight anode			
4	LEDA	LED backlight anode			
5	NC	No Connection			
6	NC	No Connection			
7	NC	No Connection			
8	/RESET	System Reset			
9	SPENA	SPI ENABLE			
10	SPCLK	SERIAL CLOCK SIGNAL			
11	SPDAT	SERIAL DATA SIGNAL			
12	DB0				
13	DB1				
14	DB2				
15	DB3				
16	DB4				
17	DB5				
18	DB6				
19	DB7				
20	DG0				
21	DG1				
22	DG2				
23	DG3				
24	DG4	RGB Data Bus			
25	DG5				
26	DG6				
27	DG7				
28	DR0				
29	DR1				
30	DR2				
31	DR3				
32	DR4				
33	DR5				
34	DR6				
35	DR7				
36	HSYNC	Line synchronizing signal for RGB interface operation			
37	VSYNC	Frame synchronizing signal for RGB interface operation			
38	DOTCLK	Dot Clock			
39	NC	No Connection			



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40	NC	No Connection
41	VCC	Power supply
42	VCC	Power supply
43	NC	No Connection
44	NC	No Connection
45	NC	No Connection
46	NC	No Connection
47	NC	No Connection
48	SEL2	Input Interface Mode
49	SEL1	Input Interface Mode
50	SEL0	Input Interface Mode
51	NC	No Connection.
52	DEN	Display enable pin from controller
53	GND	Power ground
54	GND	Power ground

Note:

SEL2	SEL1	SEL0	Format	Operating Frequency
0	0	0	Parallel-RGB data format (only support stripe type color filter)	6.5MHz
0	0	1	Serial-RGB data format	19.5MHz
0	1	0	CCIR 656 data format (640RGB)	24.54MHz
0	1	1	CCIR 656 data format (720RGB)	27MHz
1	0	0	YUV mode A data format (Cr-Y-Cb-Y)	24.54MHz
1	0	1	YUV mode A data format (Cr-Y-Cb-Y)	27MHz
1	1	0	YUV mode B data format (Cb-Y-Cr-Y)	27MHz
1	1	1	YUV mode B data format (Cb-Y-Cr-Y)	24.54MHz

Input format	DOTCLK Freq (MHz)	Display Data	Active Area (DOTCLK)
YUV mode	24.54	640	1280
	27	720	1440



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5. Absolute Maximum Ratings

Item	Symbol	Min.	Max.	Unit
Supply Voltage	VCC	-0.3	4.0	V
Input Voltage	Vin	GND-0.3	4.0	V
Operating Temperature	Тор	-20	70	°C
Storage Temperature	Тѕт	-30	80	°C
Storage Humidity	HD		90	%RH

6. DC Characteristics

Item	Symbol	Min.	Тур.	Max.	Unit	Remark
Supply Voltage	VCC	2.5		3.6	V	
Input High Voltage	V _{IH}	0.8 VCC		VCC	V	Digital input pins
Input Low Voltage	V_{IL}	0		0.2 VCC	V	Digital input pins
Output High Voltage	V _{OH}	0.9 VCC		VCC	V	Digital output pins
Output Low Voltage	V_{OL}	0		0.1 VCC	V	Digital output pins
Logic Input Current	IIL/IIH	-1		1	uA	

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7. Timing Characteristics7.1 Pixel Timing Characteristics

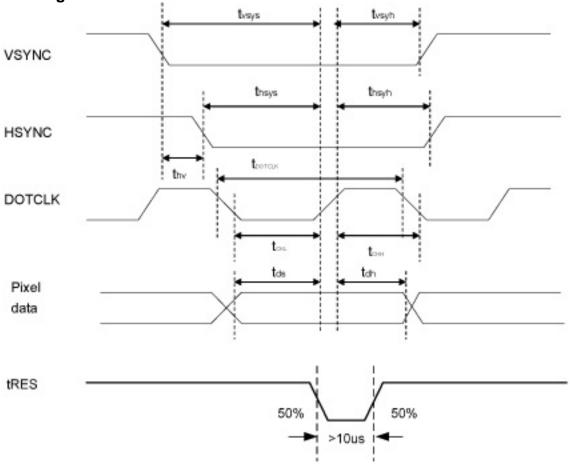


Figure 7. 1 Pixel Timing

Characteristics	Symbol Min.		Тур.		Max.		Unit	
	Symbol	24 bit	8 bit	24 bit	8 bit	24 bit	8 bit	Onit
DOTCLK Frequency	fDOTCLK	-	-	6.5	19.5	10	30	MHz
DOTCLK Period	tDOTCLK	100	33.3	154	51.3	-		ns
Vertical Sync Setup Time	tvsys	20	10	-	-	-	-	ns
Vertical Sync Hold Time	tvsyh	20	10	-	-	-		ns
Horizontal Sync Setup Time	thsys	20	10					ns
Horizontal Sync Hold Time	thsyh	20	10		-	-	-	ns
Phase difference of Sync Signal Falling Edge	thv	1				24	10	tDOTCLK
DOTCLK Low Period	tCKL	50	15	-	-	-	-	ns
DOTCLK High Period	tCKH	50	15		-	-	-	ns
Data Setup Time	tds	12	10	-		-	- 2	ns
Data hold Time	tdh	12	10					ns
Reset pulse width	tRES	1	0	-				μs

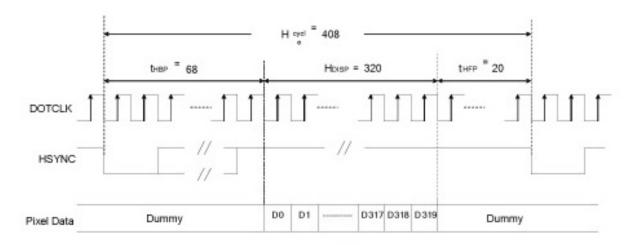
Note: External clock source must be provided to DOTCLK pin of HX8238-D. The driver will not operate if absent of the clocking signal.

Table 7. 1 Pixel Timing

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7.2 RGB Interface Timing Characteristics





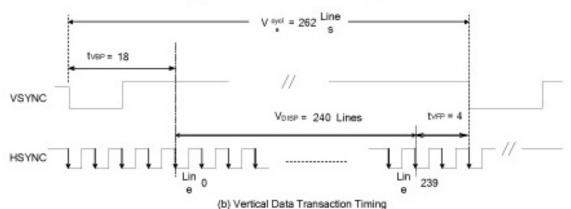


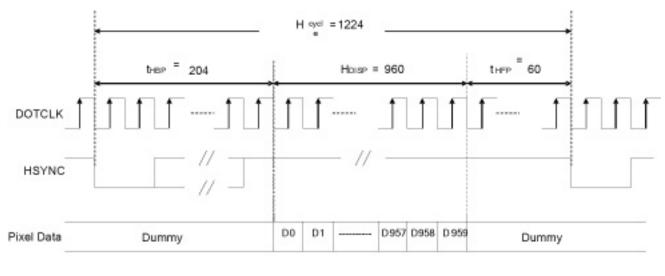
Figure 7. 2 Data Transaction Timing in Parallel RGB (24 bit) Interface (SYNC Mode)

Characteris	tios	Symbol	Mi	n.	Ty	p.	Ma	ax.	Unit
Characteristics		Symbol	24 bit	8 bit	24 bit	8 bit	24 bit	8 bit	Onit
DOTCLK Frequen	icy	fDOTCLK	-	-	6.5	19.5	10	30	MHz
DOTCLK Period	Section 1	tDOTCLK	100	33.3	154	51.3	-	-	ns
Horizontal Freque	ncy (Line)	fH	-		14	.9	22	.35	KHz
Vertical Frequency	y (Refresh)	fV	-	3.6	6	0	9	0	Hz
Horizontal Back P		tHBP		-	68	204	-	-	†DOTCLK
Horizontal Front P	orch	tHFP	-	-	20	60	-	-	*DOTCLK
Horizontal Data St	tart Point	tHBP			68	204	-	-	tDOTCLK
Horizontal Blankin	g Period	tHBP + tHFP			88	264	-	-	tDOTCLK
Horizontal Display Area		HDISP	-	-	320	960	-	-	tDOTCLK
Horizontal Cycle		Hcycle	-	-	408	1224	450	1350	tDOTCLK
Vertical Back Porc	ch	tVBP	-		18		-		Lines
Vertical Front Por	ch	tVFP	-		4		-		Lines
Vertical Data Star	t Point	tVBP			18				Lines
Vertical Blanking	Period	tVBP + tVFP			22		-		Lines
NTSC					240				
Vertical Display Area	PAL	VDISP	- 280(PALM=0) - 288(PALM=1)		280(PALM=0)		1		Lines
	PAL					20000000			
Vertical Cycle	NTSC	Manuala	-	-		262		FA	Lines
	PAL	Vcycle			31	13	3	50	Lines

Table 7. 2 Data Transaction Timing in Normal Operating Mode

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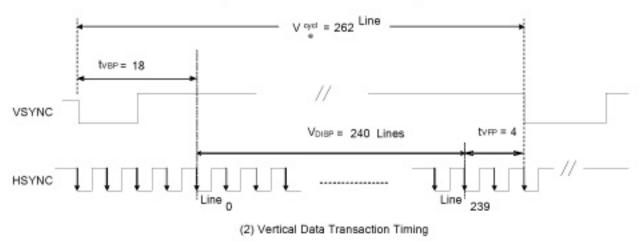
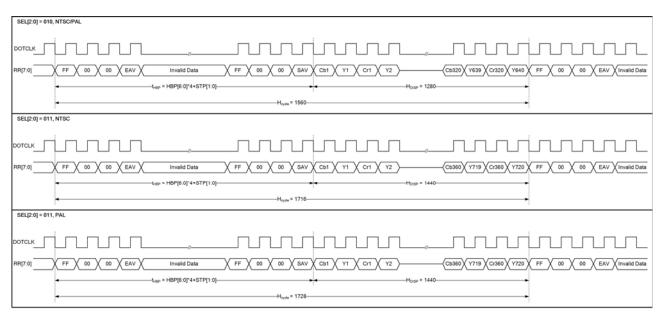


Figure 7. 3 Data Transaction Timing in Serial RGB (8 bit) Interface (SYNC Mode)

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7.3 CCIR656 Timing Characteristics



Figur 7.4 CCIR656 Horizontal Timing

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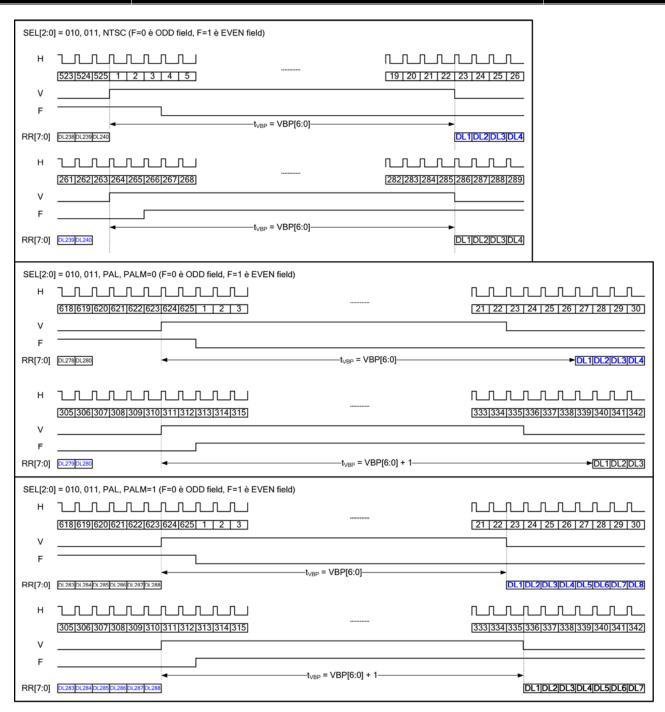


Figure 7.5 CCIR656 Vertical Timing



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8. Backlight Characteristics

BL Circuit Diagram:



Item	Symbol	MIN	TYP	MAX	UNIT	Test Condition
Supply Voltage	Vf	18	19.2	20	V	If=20mA
Supply Current	If		20		mA	
Luminous Intensity for LCM		200	250		Cd/m ²	If=20mA
Uniformity for LCM		80			%	If=20mA
Life Time		50000			Hr	If=20mA
Backlight Color				White		

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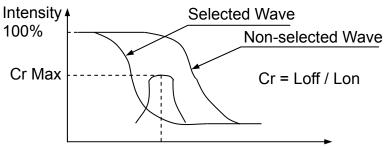
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9. Optical Characteristics

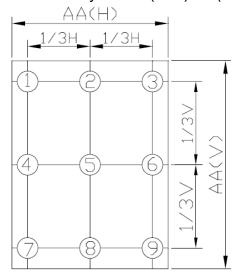
(Note1, Note2) (Using Normal Polarizer +CPT Backlight, reference only)

ITEM		SYMBOL	CONDITION	MIN.	TYP.	MAX.	UNIT	REMARK
Brightness		BL	θ =φ= 0°	200	250		cd/m²	Note2
Contrast	Ratio	CR	$\theta = \phi = 0^{\circ}$	150	250			Note3
Response	Time	Tr+ Tf	θ =φ= 0°		50	70	ms	Note4
	Upper	Φ			45		-	Note 5
Viewing	Down	ð	CR≧10		45			
Angle	Right				35			
	Left	φ			15			
	White	Х	$\theta = \phi = 0^{\circ}$	0.264	0.294	0.324		
	vviile	у	θ = ψ= 0	0.304 0.334	0.364			
	Red	X	$\theta = \phi = 0^{\circ}$	0.603	0.633	0.663		Note 6
Color Filter	ivea	у	υ =ψ= υ	0.296	96 0.326 0.356	0.356	I	
Chromaticity	Green	Х	Δ = ω - 0°	0.267	0.297	0.327		
	Gieen	у	$\theta = \phi = 0^{\circ}$	0.547	0.577	0.607		
	Rlug	Х	$\theta = \phi = 0^{\circ}$	0.103	0.133	0.163		
	Blue	у	υ –ψ= υ	0.099	0.129	0.159		

Note1: Definition of Operation Voltage (Vop)



Vop Driving Voltage ($^{\circ}$ V) Note2: Definition of Luminance Uniformity : L = L(MIN) / L (MAX) × 100%



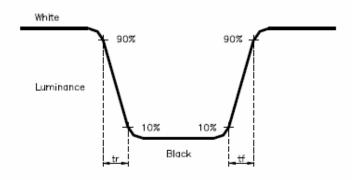
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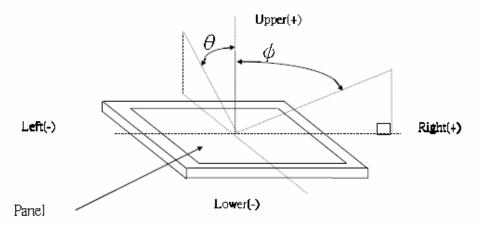
Note 3. Definition of Contrast Ratio:

CR = White Luminance (ON) / Black Luminance (OFF)

Note 4. Definition of response time: The response time is defined as the time interval between the 10% and 90% amplitudes.



Note 5. Definition of view angle(θ , ψ):



Note 6. Light source: Clight.



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10. Reliability Test Conditions and Methods

NO.	TEST ITEMS	TEST CONDITION	INSPECTION AFTER TEST			
	High Temperature Storage	80°C±2°C×200Hours				
	Low Temperature Storage	-30°C±2°C×200Hours				
	High Temperature Operating	70°C±2°C×120Hours	Inspection after 2~4hours storage at room temperature, the samples should be free from defects: 1, Air bubble in the			
	Low Temperature Operating	-20°C±2°C×120Hours				
	Temperature Cycle(Storage)	$ \begin{array}{cccccccccccccccccccccccccccccccccccc$	LCD. 2, Seal leak. 3, Non-display. 4, Missing segments. 5, Glass crack.			
	Damp Proof Test (Storage)	50°C±5°C×90%RH×120Hours	6, Current IDD is twice higher than initial value.			
	Vibration Test	Frequency:10Hz~55Hz~10Hz Amplitude:1.5M X,Y,Z direction for total 3hours (Packing Condition)	7, The surface shall be free from damage. 8, The electric characteristic requirements shall be			
	Drop to the ground from 1M heigone time every side of carton. (Packing Condition)		satisfied.			
	ESD Test	Voltage:±8KV,R:330Ω,C:150PF,Air Mode,10times				

REMARK:

- 1, The Test samples should be applied to only one test item.
- 2, Sample side for each test item is 5~10pcs.
- 3,For Damp Proof Test, Pure water(Resistance $> 10M\Omega$)should be used.
- 4,In case of malfunction defect caused by ESD damage, if it would be recovered to normal state after resetting, it would be judge as a good part.
- 5, EL evaluation should be accepted from reliability test with humidity and temperature: Some defects such as black spot/blemish can happen by natural chemical reaction with humidity and Fluorescence EL has.
- 6, Failure Judgment Criterion: Basic Specification Electrical Characteristic, Mechanical Characteristic, Optical Characteristic.



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11. Inspection Standard

This standard apply to C-STN/TFT module

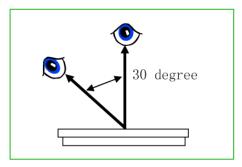
1. Spot check plan:

According to spot check level ${\rm II}$,MIL-STD-105D Level ${\rm II}$,the rank of accept or reject is below:

3A、2A: major non-conformance: AQL 0.25 minor non-conformance: AQL 0.4

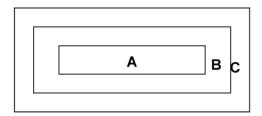
1A: major non-conformance: AQL 0.65 minor non-conformance: AQL 1.

2. Inspection condition:



Under daylight lamp 20 \sim 40W, product distance inspector 'eye 30cm,incline degree 30° $_{\circ}$

3. LCD area define:



Area A: display area

Area B: VA area

Area C: out of VA area, not in sight after assembly

Remark: non-conformance at area C, but is OK that isn't influence reliability of product & assembly by customer.



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4. Inspection standard

4.1 Major non-conformance

NO.	Item	Inspection standard	Rate
4.1.1	Function non-conformance	 No display, display abnormally Miss line, short B/L no function or function abnormally TP no function 	major
4.1.2	miss	No matter miss what component	
4.1.3	Out of size	Module dimension out of spec	

4.2 Appearance non-conformance

NO.	Item			Inspe	ection sta	anda	rd		Rate
		dot non-conformance define Φ $\Phi = \frac{-+y}{2} x ($							
		A grade Most approve q'ty					a tu	\neg	
	Black or	area size (mm)		Α			С		
4.2.1	white spot (power	Ф≤0.1	Ф≤0.10		ignore				Minor
	on)	0.10<Φ≤	0.15	4					
		0.15<Φ≤0.20			2		ignore	•	
		0.20<Φ≤0.25		1					
		0.25<Ф		0					
		Most approve 4 damages, dot to dot ≥10mm							
		A grade Size(mm) Most approve q'ty					a'ty		
		L(length)	W(width)		Α '	VIOSE	В	C	
		L(longur)	,						
		ignore	W≤	0.03	ig	gnore	•		
4.2.2	Black or white line (power on)	L≤5.0	0.03< W≤0.05		3				Minor
		L≤3.0	0.05< W≤0.07		2			ignore	
			0.07 <w< td=""><td colspan="2">Treat with dot non-conformance</td><td></td><td></td><td></td></w<>		Treat with dot non-conformance				
		Most approv	ve 3 da	mages	, line to I	ine	≥10mm		



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4.2.3	Polarizer position		arizer must co		allow out of LCD. irea (special req	uire Minor		
4.2.4	LCD non-conform ance	(iii) con	X ≤3.0 Crash disall monly surface X X ≤2.0	Y <frame edge<="" th=""/> <th>Z ignore</th> <th>Minor</th>	Z ignore	Minor		
4.2.5	Contrast voltage warp	VOP/VIcd voltage of confirmed sample \pm 0.15V						
4.2.6	color	Color &	luminance of I	module scope r	eference spec	Minor		
4.2.7	Cross talk	Referen	ce confirmed l	imit sample		Minor		



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12. Handling Precautions

12.1 Mounting method

The LCD panel of AMSON TFT module consists of two thin glass plates with polarizes which easily be damaged. And since the module in so constructed as to be fixed by utilizing fitting holes in the printed circuit board.

Extreme care should be needed when handling the LCD modules.

12.2 Caution of LCD handling and cleaning

When cleaning the display surface, Use soft cloth with solvent

[Recommended below] and wipe lightly

- Isopropyl alcohol
- Ethyl alcohol

Do not wipe the display surface with dry or hard materials that will damage the polarizer surface.

Do not use the following solvent:

- Water
- Aromatics

Do not wipe ITO pad area with the dry or hard materials that will damage the ITO patterns Do not use the following solvent on the pad or prevent it from being contaminated:

- Soldering flux
- Chlorine (CI) , Sulfur (S)

If goods were sent without being sili8con coated on the pad, ITO patterns could be damaged due to the corrosion as time goes on.

If ITO corrosion happen by miss-handling or using some materials such as Chlorine (CI), Sulfur (S) from customer, Responsibility is on customer.

12.3 Caution against static charge

The LCD module use C-MOS LSI drivers, so we recommended that you:

Connect any unused input terminal to VDDIO or GND, do not input any signals before power is turned on, and ground your body, work/assembly areas, and assembly equipment to protect against static electricity.

12.4 packing

- Module employs LCD elements and must be treated as such.
- Avoid intense shock and falls from a height.
- To prevent modules from degradation, do not operate or store them exposed direct to sunshine or high temperature/humidity

12.5 Caution for operation

- It is an indispensable condition to drive LCD's within the specified voltage limit since the higher voltage then the limit cause the shorter LCD life.
- An electrochemical reaction due to direct current causes LCD's undesirable deterioration, so that the use of direct current drive should be avoided.
- Response time will be extremely delayed at lower temperature then the operating temperature range and on the other hand at higher temperature LCD's how dark color in them. However those phenomena do not mean malfunction or out of order with LCD's, which will come back in the specified operation temperature.
- If the display area is pushed hard during operation, some font will be abnormally displayed but it resumes normal condition after turning off once.
- Slight dew depositing on terminals is a cause for electro-chemical reaction resulting in terminal open circuit.
 - Usage under the maximum operating temperature, 50%Rh or less is required.



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12.6 storing

In the case of storing for a long period of time for instance, for years for the purpose or replacement use, the following ways are recommended.

- Storage in a polyethylene bag with the opening sealed so as not to enter fresh air outside in it. And with no desiccant.
- Placing in a dark place where neither exposure to direct sunlight nor light's keeping the storage temperature range.
- Storing with no touch on polarizer surface by the anything else.
 [It is recommended to store them as they have been contained in the inner container at the time of delivery from us.

12.7 Safety

- It is recommendable to crash damaged or unnecessary LCD's into pieces and wash off liquid crystal by either of solvents such as acetone and ethanol, which should be burned up later.
- When any liquid leaked out of a damaged glass cell comes in contact with your hands, please wash it off well with soap and water.

13. Precaution for Use

13.1

A limit sample should be provided by the both parties on an occasion when the both parties agreed its necessity. Judgment by a limit sample shall take effect after the limit sample has been established and confirmed by the both parties.

13.2

On the following occasions, the handing of problem should be decided through discussion and agreement between responsible of the both parties.

- When a question is arisen in this specification.
- When a new problem is arisen this is not specified in this specification.
- When an inspection specifications change or operating condition change in customer is reported to AMSON TFT and some problem is arisen in this specification due to the change.
- When a new problem is arisen at the customer's operating set for sample evaluation in the customer site.

14. Packing Method TBD